

Submission Due Oct. 15, 2024

Notification Due Nov. 5, 2024

Registration Due Nov. 25, 2024

◆ Publication

Accepted and registered papers with presentation will be published in below listed journals of **Scientific.Net** collection, which will be indexed by **Scopus**, etc



Materials Science Forum (MSF)



Solid State Phenomena (SSP)



Defect and Diffusion Forum (DDF)



Key Engineering Materials (KEM)

◆ Publication History

ICNMS 2024 - Materials Science Forum

ICNMS 2023 - Key Engineering Materials Vol.953. Indexed by Scopus!

ICNMS 2022 - Materials Science Forum Vol.1067. indexed by Ei Compendex & Scopus!

ICNMS 2021 - Key Engineering Materials Vol.891. Indexed by Ei Compendex & Scopus!

ICNMS 2020 - IOP Conference Series: Materials Science and Engineering Vol. 842

ICNMS 2019 - American Institute of Physics)AIP Vol. 2083. Indexed by Scopus!

ICNMS 2018 - American Institute of Physics)AIP Vol. 1957. Indexed by Scopus!

ICNMS 2017 - Nano Hybrids and Composites (NHC)Vol. 16

ICNMS 2016 - MATEC Vol. 43, 2016. Indexed by Ei Compendex!

◆ Submission Methods

Online Submission System:

<http://confsys.iconf.org/submission/icnms2025>

Email Submission:

icnms@saise.org

Full Paper Template (Publication and Oral Presentation)

***English, no less than 5 pages**

Abstract Template (Oral Presentation Only)

◆ Conference Committee

Conference Chairs

Ramesh K. Agarwal (Fellow of IEEE, AAAS, AIAA, APS, ASME, CSAA, SME and ASEE), Washington University in St. Louis, USA
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◆ Conference Topics

Materials behavior

Casting and solidification

Powder metallurgy and ceramic forming

Surface, subsurface, and interface phenomena

Coatings and surface engineering

Manufacturing process planning and scheduling

Meso/micro manufacturing equipment and processes

Modeling, analysis, and simulation of manufacturing processes

Computer-aided design, manufacturing, and engineering

Semiconductor materials manufacturing

Joining processes

Materials forming

Rapid manufacturing technologies

Nontraditional manufacturing

Nanofabrication, nanometrology and applications

Nanomaterials and nanomanufacturing

Biomedical manufacturing

Environmentally sustainable manufacturing processes and systems

More topics, please visit:

<https://www.icnms.org/cfp.html>

